

WHAT IS CLAIMED IS:

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1. A light-emitting apparatus comprising:
a primary light source including a semiconductor
light-emitting device with an emission wavelength of from 380
5 nm to 500 nm; and
a secondary light source including a fluorescent material
composed of ZnS:Cu, Au, Al;
wherein said secondary light source emits light based
on light given from said primary light source so that light
10 of said secondary light source and the light of said primary
light source are mixed together to thereby generate light
different in luminescent color from the light emitted from said
primary light source.

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15 2. A light-emitting apparatus according to claim 1,
wherein said fluorescent material is dispersed into a first
layer composed of a light-transmissible material,
a part of the light emitted from said primary light source
is transmitted through said first layer, and
20 the other part of the light emitted from said primary
light source is absorbed by said fluorescent material so that
said fluorescent material emits light and the light emitted
from said fluorescent material and the light emitted from said
primary light source are mixed together to thereby generate
25 light different in luminescent color from the light emitted

8. A light-emitting apparatus according to claim 2, wherein an amount of said fluorescent material changes continuously or stepwise as location of said fluorescent material in said first layer comes nearer said light-emitting device.

9. A light-emitting apparatus according to claim 5, wherein said first layer and said sealing member are composed of the same material.

10. A light-emitting apparatus according to claim 2, wherein said light-emitting device is of a chip type, and said first layer is formed so as to cover said light-emitting device.

11. A light-emitting apparatus comprising:
a primary light source including a semiconductor light-emitting device with an emission wavelength of from 380 nm to 500 nm; and

a secondary light source including a fluorescent material composed of at least one member selected from the group consisting of ZnS:Eu, YVO₄:Ce and Y₂O₂S:Ce;

wherein said secondary light source emits light based on light given from said primary light source so that light of said secondary light source and the light of said primary

light source are mixed together to thereby generate light different in luminescent color from the light emitted from said primary light source.

5 12. A light-emitting apparatus according to claim 11, wherein said fluorescent material is dispersed into a first layer composed of a light-transmissible material,

a part of the light emitted from said primary light source is transmitted through said first layer, and

the other part of the light emitted from said primary light source is absorbed by said fluorescent material so that said fluorescent material emits light and the light emitted from said fluorescent material and the light emitted from said primary light source are mixed together to thereby generate
15 light different in luminescent color from the light emitted from said primary light source.

13. A light-emitting apparatus according to claim 12, wherein said first layer comprises at least one member selected
20 from the group consisting of epoxy resin, silicone resin, urea resin and glass.

14. A light-emitting apparatus according to claim 12, wherein said light-emitting device is fixed to a cup portion
25 of a lead frame, and said first layer is formed so that said

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and emitting red light.

24. A light-emitting apparatus according to claim 23,
wherein said second fluorescent material is composed of CaS:Eu .

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25. A light-emitting apparatus according to claim 21,
wherein said third light source includes a semiconductor
light-emitting device for emitting red light.

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26. A light-emitting apparatus according to claim 21,
wherein said fluorescent material is dispersed into a first
layer composed of a light-transmissible material,

a part of the light emitted from said first light source
is transmitted through said first layer, and

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the other part of the light emitted from said first light
source is absorbed by said fluorescent material so that said
fluorescent material emits light and the light emitted from
said fluorescent material and the light emitted from said first
light source are mixed together to thereby generate light
different in luminescent color from the light emitted from said
first light source.

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27. A light-emitting apparatus according to claim 26,
wherein said first layer comprises at least one member selected
from the group consisting of epoxy resin, silicone resin, urea

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resin and glass.

28. A light-emitting apparatus according to claim 26,
wherein said light-emitting device is fixed to a cup portion
5 of a lead frame, and said first layer is formed so that said
light-emitting device fixed to said cup portion is covered with
said first layer.

29. A light-emitting apparatus according to claim 28,
10 wherein a sealing member is provided so that said light-emitting
device, said first layer and a part of said lead frame are covered
with said sealing member.

30. A light-emitting apparatus according to claim 29,
15 wherein said sealing member is composed of at least one member
selected from the group consisting of epoxy resin, silicone
resin, urea resin and glass.

31. A light-emitting apparatus according to claim 29,
20 wherein said sealing member is shaped like a bullet.

32. A light-emitting apparatus according to claim 26,
wherein an amount of said fluorescent material changes
continuously or stepwise as location of said fluorescent
25 material in said first layer comes nearer said light-emitting

device.

33. A light-emitting apparatus according to claim 29,
wherein said first layer and said sealing member are composed
of the same material.

34. A light-emitting apparatus according to claim 26,
wherein said light-emitting device is of a chip type, and
said first layer is formed so as to cover said light-emitting
device.

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